Sheet 1 of 1 Serial No. 09/38/323 Group Art Unit 2827 Filing Date Subclass If appropriate Translation Subclass Yes No Abstract X X Abstract X

...t No. 37 CFR 1.501 · P99.1696 INFORMATION DISCLOSURE STATEMENT Applicants IN A PATENT Thomas Aeugle, et al. (use several sheets if necessary) Filing Date 09/16/1999 **U.S. PATENT DOCUMENTS** Examiner's Initials Document Number Date Name Class. 05-04-93 AA 5,208,172 J. Fitch, et al. 08-13-96 AB 5,545,586 R. Koh 12-27-94 AC 5,376,562 J. Fitch, et al. AD AE AF AG AH ΑI ΑJ AK FOREIGN PATENT DOCUMENTS **Document Number** Date Country Class 06-01-88 EP 0 268 941 Europe AL AM EP 0 430 514 06-05-91 Europe DE 196 21 244 11-14-96 Germany AN AO AP AO OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.) R. Loo, et al., "Vertical Si p-MOS transistor selectively grown by low pressure chemical vapour AR deposition", Thin Solid Films, Vol. 294, p. 267 (1997) D. Behammer, "Selectively grown vertical Si-p MOS transistor with short channel lengths", Electronics AS. Letters, Vol. 32, No. 4, p. 406 (15 February 1996) L. Risch, et al., "Vertical MOS Transistors with 70 nm Channel Length", ESSDERC 1995, p. 101 AT "Roadmap for Semiconductors", Solid State Technology, Vol. 3, February 1995, pp. 42 ΑU A. Hori, et al., "A 0.05 µm-CMOS with Ultra Shallow Source/Drain Junctions Fabricated by SKeV Ion Implantation and Rapid Thermal Annealing", IEDM 94 p. 485 H. Hu, et al., "Channel and Source/Drain Engineering in High-Performance Sub-0.1 µm NMOSFETs Using X-Ray Lithography*, 1994 Symposium on VLSI Technology Digest of Technical Papers, p. 17 L. Vescan, "Radiative Recombination in SiGe/Si Dots and Wires Selectively Grown by LPCVD". Material Science and Engineering, Vol. 28, p. 173 (1994) Date Considered Examiner Thank Tran *EXAMINER: Initial if reference considered, whether r not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy f this form with next communication t

applicant.